FEATURES AND SPECIFICATIONS

查询"78320-0001"供应商

Molex introduces the micro Serial ATA (SATA) interconnect solution for 1.8" form factor drives and backplane applications.

In April 2007, the Serial ATA International Organization (SATA-IO) annnounced the release of new specs for the SATA interconnect solutions. The new 2.6 revision covers the addition of new features to the specs making SATA available for new applications. One of the new features is the provision for the application of 1.8" SATA form factor drives in both HDD (hard disk drive) and SSD (solid state drive) types. Applications include laptop computers, set top boxes and game consoles.

Molex Micro SATA connectors are compliant to SATA-IO standards with respect to the mating interface. These standards define features such as 7 signal pins, 9 power pins with power segment key, staggered contact lengths for hot plugging, guide posts and pockets for blindmating, friction locking for cabling and high data-transfer rate of 3.0Gbps. The combo device plug supports internal 5.00mm and 8.00mm slim 1.8" form factor drives while the right angle Micro SATA combo receptacle supports backplane applications.

The connectors contained in this release are ELV and RoHS compliant. They are also lead free process compatible.

Molex is an active member of the SATA-IO. The working group is responsible for developing and specifying Serial ATA interconnect standards.



1.27mm (.050") Pitch Micro SATA

78285 / 78103 Combo Plug

78320 / 78109 Combo Receptacle



Features	Benefits		
Staggered contact lengths (First-Mate-Last-Break)	 Allows sequential mating of pins for hot-plugging of device drive 		
Guide pocket for plug and guide post for receptacle	Allows blind-mating		
Power segment key	 Prevents insertion of non-micro SATA power cables 		
High temperature thermoplastic housing	Provides lead-free process capability		
 Plastic locating peg for plug 	Ensures proper locating on PCB		
Metal locating pin for receptacle	Ensures proper locating on PCB and extra retention to PCB		
• Friction locking	 Ensures secure mating of connectors and cable assemblies 		
Solder tab	 Provides extra retention to PCB 		

SPECIIFICATIONS : PLUG

Reference Information
Packaging: Tray
UL File No.: Pending
CSA File No.: Pending

Mates With: Micro SATA Combo Receptacle

Designed In: Millimeters

Electrical

Voltage: 30V Max Current: 1.5A

Contact Resistance: 30 milliohms max.
Dielectric Withstanding Voltage: 500V AC
Insulation Resistance: 1000 Megohms min.

Mechanical

Mating Force: 20N (4.50 lb) max. with backplane receptacle

45N (10.11 lb) max. with non latching power & signal cable receptacles

Unmating Force: 2.5N (0.56 lb) min. with backplane receptacle

8N (1.8 lb) min. with non latching power cable receptacle 10N (2.25 lb) min. with non latching signal cable receptacle

Durability: 50 cycles for internal cable application

500 cycles for backplane application

Physical

Housing: LCP, Glass Filled, UL 94V-0, Black

Contact: Copper Alloy

Platina:

Contact Area — 0.76µm min. Gold (Au) Solder Tail Area — 0.05µm min. Gold (Au)

Underplating — Nickel (Ni)

PCB Thickness: 0.35mm

Operating Temperature: -40°C to +105°C



SPECIIFICATIONS: RECEPTACLE

查询"78320-0001"供应商

Reference Information Packaging: Tray UL File No.: Pending CSA File No.: Pending

Mates With: Micro SATA Combo Plug

Designed In: Millimeters

Electrical Voltage: 30V Max Current: 1.5A

Contact Resistance: 30 milliohms max. Dielectric Withstanding Voltage: 500V AC Insulation Resistance: 1000 Megohms min.

Mechanical

Mating Force: 20N (4.50 lb) max. Insertion Force Unmating Force: 2.5N (0.56 lb) min. Removal Force Durability: 500 cycles for backplane application.

Physical

Housing: Nylon (PA) 9T, Glass Filled, UL 94V-0, Black

Contact: Copper Alloy

Plating:

Contact Area — 0.76µm min. Gold (Au)

Solder Tail Area — Tin (Sn) Underplating — Nickel (Ni)

PCB Thickness: 0.80mm

Operating Temperature: -40°C to +105°C

1.27mm (.050") Pitch Micro SATA

78285 / 78103

Combo Plug

78320 / 78109

Combo Receptacle

MARKETS AND APPLICATIONS

Regional Markets, Applications and Typical Customers

- Mobile Computing
 - Notebook PC
 - Sub-notebook PC
- Emerging Trends
 - Set Top Box
 - Game Consol
 - Solid State Drives







ORDERING INFORMATION

Description	Order No.	Drive Type	Mating Z-Height	Drive form factor
1.27mm (.050") Pitch Micro SATA Device Plug, Surface Mount	<i>7</i> 8103-0001	HDD	Datum A to PCB sitting plane, 3.15mm	
	<i>78285-0001</i>	SSD	Datum A to PCB sitting plane, 1.29mm	
1.27mm (.050") Pitch Micro SATA Right Angle, Receptacle, Surface Mount	78109-0001	HDD / SSD -	Datum A to PCB sitting plane, 1.15mm, Mid Mount	1.8″
	78320-0001		ענג / עעח	ענג / טטח



Americas Headquarters 2222 Wellington Ct. Lisle, Illinois 60532 USA 1-800-78MOLEX amerinfo@molex.com Asia Pacific North Headquarters Yamato, Kanagawa, Japan 81-462-65-2324 feninfo@molex.com Asia Pacific South Headquarters Jurong, Singapore 65-6-268-6868 fesinfo@molex.com European Headquarters Munich, Germany 49-89-413092-0 eurinfo@molex.com

Corporate Headquarters 2222 Wellington Ct. Lisle, Illinois 60532 USA 630-969-4550